



Request for Quote and Specifications of Electroplating Tool

- The GEECI (Gallium Nitride Ecosystem Enabling Centre and Incubator) at SID-Indian Institute of Science is seeking bids from qualified industries for a electroplating tool as per the specifications below.
- Companies need to submit two bids, a technical bid and a commercial bid, in **two separate** sealed envelopes. The bids should be submitted no later than 30 days from the date of posting of this tender, as listed on the website date/time stamp, and by 5 pm on the 30th day or next weekday in case the 30th day falls on a weekend or a national holiday.
- Both technical and commercial bids should be addressed to “The Chief Executive, SID, IISc, Bangalore 560012, GST # 29AAATS5333E1ZJ.”
- All quotations should be CIF Bangalore.
- Cost of last mile transportation, including any insurance, from port of shipment to IISc has to be quoted as an option.
- In case of courier shipments maximum permissible weight would be 70kgs.
- The envelopes should be addressed to “Prof. Srinivasan Raghavan, CeNSE, IISc, Bangalore, 560012” and submitted to the office at CeNSE, IISc in Room No. GF 15 between 9 am and 5 pm.
- All questions regarding this tender should be addressed to Prof. Srinivasan Raghavan at the email address sraghavan@iisc.ac.in
- Post such submission all vendors should send an email to sraghavan@iisc.ac.in with the subject line: “GEECI_Bidder’s name_Tool Name” to intimate him of the submission within one day.
- Deviations from the technical specifications requested are allowed. Such deviations must be highlighted and justified. Their acceptance or rejection will be left to the discretion of the technical committee.
- The equipment sought will be placed at the Centre for Nano Science and Engineering (CeNSE), Indian Institute of Science (IISc). IISc is India’s No. 1 institution on higher learning and the Center for Nano Science and Engineering is home to one of the best academic fabs in the world.
- The technical response, corresponding to the tool being offered, should be in the form of a compliance table with at least 5 columns. Serial number in column 1. Each of the numbered technical items below should be addressed in a separate row of the table in column 2. Compliance to this requirement, in Yes/No, deviation from it and justification should be provided in the neighboring columns 3-5. Post the opening of a hard copy of the technical bid the committee will request for a soft copy of the files for further processing. Companies should **NOT** mail soft copies of the files unless specifically requested for.
- Detailed technical specifications of the tool being offered should be included.
- Any additional capabilities or technical details, that you would like to bring to the attention of the purchase committee, can be listed at the end of the technical table.
- If multiple systems can fulfill the requirements, vendors can submit multiple bids.
- Vendors are encouraged to highlight the advantages of their tools over comparable tools from the competitors.
- The commercial bid should be broken up to the maximum extent possible into separate items with a cost against each to enable better comparison of price for various configurations across the bidders. As an option, please provide itemized cost for any *suggested* accessories/add-ons that may enhance the usability, capability, accuracy or reliability of the tool. Vendors are encouraged to quote for as many add-ons as their tool portfolio permits.

S. No	Item
	Main Applications: Electroplating of gold from cyanide and sulfite baths.
1.	Supply: The set-up should comprise of electroplating unit with swivelling device which can accommodate 4-6 inch circular wafer, electrolytic tank, pump and cassette, suitable anode for uniform deposition on up to 6 inch circular wafer and a power supply unit.
2.	Electroplating unit with swivelling device will have provision for using it as a closed unit with a cassette for fixing the wafer (4- 6 inch) and provision for fixing the anode (inert or soluble, mesh or plate or pellet type) along with the pellet basket. Cassette should have arrangement for converting it into a single wafer holder. The unit will have provision for varying (a) the anode-cathode distance (1 cm to 4 cm) and (b) swiveling position (0 to 180°). Provisions should be available for housing both 4 and 6 inch wafers. Options for using smaller pieces should be provided.
3.	Please indicate if the same tool can handle up to 8” wafer sizes or if whether a different tool would be required.
4.	Anode: Suitable Anodes should be included in the quote as an option.
5.	Wafer holders: Special wafer holders if any, should be quoted as an option.
6.	Electroplating unit material: The electroplating unit will be made of material compatible with cyanide (KAuCN ₂) and sulphite gold plating solutions based on {Au(SO ₃) ₂ } ³⁻
7.	Flow rate: The electroplating unit will have inlet and outlet for electrolyte circulation by connecting it to an electrolyte tank through a pump of capacity that should be mentioned in the technical bid. The range over which flow rate can be varied will have to be specified in the technical bid. A flow rate sensor and measurement capability should be quoted as an option.
8.	Pump: Should be a magnetically coupled pump.
9.	Flow forming: A tool for flow forming should also be provided with the electroplating unit for adjusting the fluid flow over the cathode surface.
10.	Bath Temperature: An option to heat the bath must be provided to nominal temperatures of up to 80°C in a controlled fashion within +/- 1°C. For wafer sizes up to 6”, the bath size to be provide and heater rating that will allow for such temperatures should be included in the technical bid.
11.	Reservoir: A possible connection to a reservoir should be quoted as an option. Liquid transfer in this option should happen by the same pump used during plating.
12.	Lids: Bath should have a blind lid for solution coverage when not in use. Any sensors to be inserted in the bath should be done through lids with suitable feed throughs.
13.	Filter: The recirculation path should have a filter that is easily removable for cleaning purposes. The cost of the replaceable filter element should be included as an option.
14.	PC user interface: If available, a computer based user interface that allows for setting and monitoring control parameters should be provided as an option. Else, one should be able to interface the system with a computer through a suitable USB or RS232 interface.

15.	Power Supply Unit: A suitable power supply unit, DC and pulsed, that will permit the required Voltage and Current Ranges for deposition on up to 6” wafers as per the qualification and acceptance tests should be included. A nominal current density will be 1 to 10 mA/cm ² .
16.	Qualification and Acceptance Test Criteria: Vendor will have to demonstrate the ability to deposit up to 5 micron thick Au layers uniformly across a 6” wafer within +/- 2.5% uniformity at a nominal rate of 50-500 nm/min.
17.	Recipe and consumables: Vendor to include details of consumables and recipes for coating that can be provided with the tool.

	Common Terms and Conditions: A separate table to be included for each of the items below in the technical bid..
18.	Clean Room Compatibility: The system should be compatible with better than class 1000 cleanroom environment.
19.	Shipping: On all systems the cost of shipping up to IISc should be included. IISc will help with customs clearance at Bangalore Airport. Please include your payment option. IISc would prefer to retain at least 20% of payment till instruments have been commissioned and successfully demonstrated.
20.	Tool Training: The bid should include as an option the cost of training personnel on site before shipment and post installation at IISc.
21.	Tool footprint and utilities: A floor plan should be part of the technical bid. A list of utility requirements should be part of the technical bid. The system should be compatible with 240±10V, 50 Hz single phase or 415±20V, 50 Hz 3 phase supplies. The MINIMUM set of utility requirements needed are provided in Table 1. If there are additional utility requirements please include them in the technical bid. Please list connector types for all utilities.
22.	Cost of Ownership and supply of spares: The quote should include a listing of spares that need to be replaced periodically to ensure that the system is in operation in a stable fashion – the stability parameters being defined by the vendor and agreed to by the client – the cost of such items, the ability to guarantee their availability at this cost for a period of 5 years from the time of procurement. The aim of this exercise is to compare cost of ownerships between reactors.
23.	Maintenance: The cost of an annual maintenance contract and cost of emergency technical support that may involve an engineer being on site should be quoted for in the commercial bid and addressed in the technical bid. The availability of trained engineers in India for servicing the system will be preferred and should be described in the technical bid.
24.	Maintenance: On all systems a set of basic tools required -non-standard screw or spanner head that is required for routine tool maintenance should be mentioned- for performing routine maintenance should be included.
25.	Maintenance: System operation, process and troubleshooting manuals and detailed drawings are a must. Their inclusion must be indicated in the technical bid.
26.	Online support: System should have the capability for online diagnostics from a remote location in case of tool problems.
27.	Post sales service and Indian Presence: Bidders should provide details of after sales service and support available in India. If not India, the nearest geographical location should be specified. Please provide details of the number of trained personnel in India who can service the machine, the number of tools sold in India and the corresponding number in the southern region or in Bangalore.
28.	Shipping: On all systems the cost of shipping up to IISc should be included. IISc will help with customs clearance at Bangalore Airport.
29.	Payment Terms and Conditions: On all systems the payment terms should be specified in the technical and commercial proposal and is subject to negotiation. Please include your payment option. IISc would prefer to retain at least 20% of payment till instruments have been commissioned and successfully demonstrated.
30.	References: Bidders should provide details of other locations in India with similar tool installations.
31.	References: Bidders should provide details of at least 3 other locations globally where similar tool installations have been deployed for device fabrication in a clean room preferably for production purposes.
32.	Company financials: Bidder shall have to submit audited accounts of financial year 2017-18, 2018-19 and 2019-20. Audited statement must be signed and stamped by qualified chartered accountant. Income Tax return

	for assessment year – 2017-18, 2018-19 and 2019-20.
33.	The following documentation should be provided. ISO9001 quality certification. CE marking confirmation. Must confirm to SEMI standards to be specified in the technical quoted.
34.	III-V nitride processing: Please include information on whether the tool and its fixturing has been used for deposition of the said metals on GaN on Si wafers of 6” diameter for power applications.

